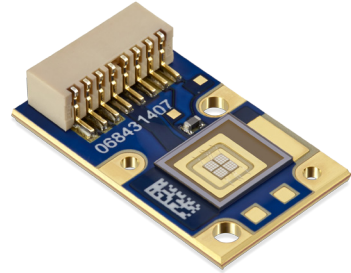


# CBM-40

## Mosaic Array Series

### Ultraviolet Chip On Board LEDs



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#### Features:

- Mosaic Array UV LED chipset with surface emitting area of 4 mm<sup>2</sup>, 1:1 aspect ratio
- All the benefits of chip on board processing without the need for complicated assembly process
- Vertical chip UV LED technology for high power density and uniform emission
- High thermal conductivity copper coreboard package
- Low-profile window for efficient coupling into small-etendue systems
- Can be operated at variable drive currents up to 6A
- NIST traceable optical and electrical measurement testing
- Environmentally friendly: RoHS and Halogen compliant

#### Applications:

- Rapid Prototyping and 3D printing
- Machine Vision
- Fiber-coupled illumination
- Specialty Projection Systems for Maskless Lithography
- Medical and Scientific Instrumentation

## Technology Overview

Luminus LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

### Luminus Mosaic Array LED Technology

Luminus' Devices vertical chip technology enables LED chips with uniform brightness over the entire chip surface. The optical power and brightness produced by these densely packed arrays of devices enable solutions not possible with single chip packages that be used to replace arc and halogen lamps.

### Packaging Technology

Thermal management is critical in high power LED applications. With a thermal resistance from junction to heat sink of 0.6 °C/W, Luminus CBM-40 LEDs have the lowest thermal resistance of any UV LED on the market. This will allow the LEDs to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

### Reliability

With designs based on years of chip and packaging development experience, Luminus LEDs are one of the most reliable light sources in the world today. Luminus LEDs pass a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that can exceed 30,000 hours, Luminus UV LEDs are ready for even the most demanding applications.

### Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All LED products manufactured by Luminus are RoHS and Halogen compliant and free of hazardous materials, including lead and mercury.

## Understanding Mosaic Array UV LED Test Specifications

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

### Testing Temperature

Luminus core board products are typically measured in such a way that the characteristics reported agree with how the devices will actually perform when incorporated into a system. This measurement is accomplished by mounting the devices on a 40°C heat sink and measuring the device while fully powered. This method of measurement ensures that Luminus LEDs perform in the field just as they are specified.

### Multiple Operating Points

The tables on the following pages provide typical optical and electrical characteristics for the standard drive conditions. Since the LEDs can be operated over a wide range of drive conditions (currents from 200 mA to 6 A, and duty cycle from <1% to 100%) there are many other potential values attainable. Driving devices beyond recommended driving conditions shortens lifetime.

### Ordering Information

Products	Ordering Part Number	Description
CBM-40-UV	CBM-40-UV-C32-FF###-2#	CBM-40 Mosaic Array UV chipset consisting of 4x1mm <sup>2</sup> UV LEDs, a thermistor, connectors, and a square copper-core PCB.

### Part Number Nomenclature

CBM — 40 — CC — C## — FF###-2#

Product Family	Chip Area	Color	Package Configuration	Bin Kit <sup>1,2</sup>
CBM: Copper-core PCB, Mosaic Array	40: 4 mm <sup>2</sup>	UV = Ultraviolet	C32: 26.5 mm x 16.0 mm	See page 5 for complete bin definition table

Note 1: A Bin Kit represents a group of individual flux or power bins that are shippable for a given ordering part number. Individual flux bins are not orderable.

Note 2: Flux Bin listed is minimum bin shipped - higher bins may be included at Luminus' discretion

### CBM-40-UV Binning Structure

CBM-40-UV LEDs are specified for luminous flux and chromaticity/wavelength at a drive current of 3 A (750 mA/mm<sup>2</sup>) and placed into one of the following Power Bins and Wavelength Bins:

#### Power Bins<sup>3</sup>

Color	Power Flux Bin (FF)	Minimum Flux (W)	Maximum Flux (W)
UV	BC	2.7	3.0
	CA	3.0	3.3
	CB	3.3	3.7
	CC	3.7	4.0
	DA	4.0	4.3
	DB	4.3	4.7

Note 3: Luminus maintains a +/- 6% tolerance on power measurements.

#### Peak Wavelength Bins

Color	Wavelength Bin (###)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
UV	365	365	370
	370	370	375
	385	385	390
	390	390	395

**CBM-40 UV Mosaic Array Bin Kits**

Wavelength Range	Luminous Flux		Wavelength Bins	Ordering Bin Kit Number
	Bin Kit Flux Code	Min. Flux		
365-375	BC	2.7	365	BC365-21
			365, 370	BC365-22
385-395	CC	3.7	385, 390	CC385-22
	DA	4.0	385	DA385-21
			390	DA390-21
			385, 390	DA385-22

**Reference Optical & Electrical Characteristics ( $T_{hs} = 40^{\circ}\text{C}$ )<sup>4,5</sup>**

UV				
Parameter	Symbol	Values <sup>6</sup>		Unit
Peak Wavelength Range	$\lambda$	365 - 375	385-395	nm
Drive Conditions <sup>7</sup>	$I$	3.0	3.0	A
Peak Wavelength Typ.	$\lambda_p$	368	387   392	nm
Current Density	$j$	0.75	0.75	A/mm <sup>2</sup>
Forward Voltage	$V_{Fmin}$	3.0	3.0	V
	$V_F$	3.7	3.6	V
	$V_{Fmax}$	4.0	4.0	V
Radiometric Flux <sup>8</sup>	$\Phi_{typ}$	2.8	4.1	W
FWHM at 50% of $\Phi$	$\Delta\lambda_{1/2}$	14	14	nm

Parameter	Symbol	Values	Unit
Absolute Minimum Current (CW or Pulsed) <sup>9</sup>		0.2	A
Absolute Maximum Current (CW) <sup>10</sup>		6	A
Absolute Maximum Surge Current <sup>10</sup> (Frequency > 240 Hz, duty cycle =10%, t=1ms)		8	A
Maximum Junction Temperature <sup>11</sup>	$T_{jmax}$	100	°C
Storage Temperature Range		-40 to +100	°C
Emitting Area		4.4	mm <sup>2</sup>
Emitting Area Dimensions		2.2 x 2.2	mm x mm

Note 4: Data verified using NIST traceable calibration standard.

Note 5: All data are based on test conditions with a constant heat sink temperature  $T_{hs} = 40^{\circ}\text{C}$  under pulse testing conditions. Pulse conditions: 25% duty-cycle, frequency of 720Hz, 3 second soak.

Note 6: Unless otherwise noted, values listed are typical. Devices are production tested and specified at 3 A.

Note 7: Listed drive conditions are typical for common applications. CBM40-UV devices can be driven at CW currents ranging from 200 mA to 6 A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.

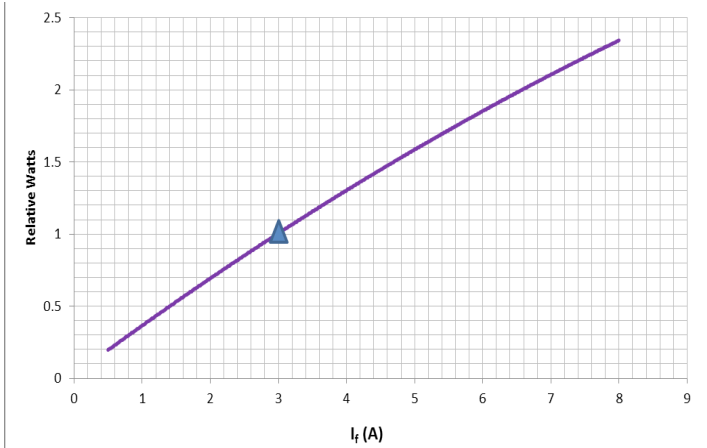
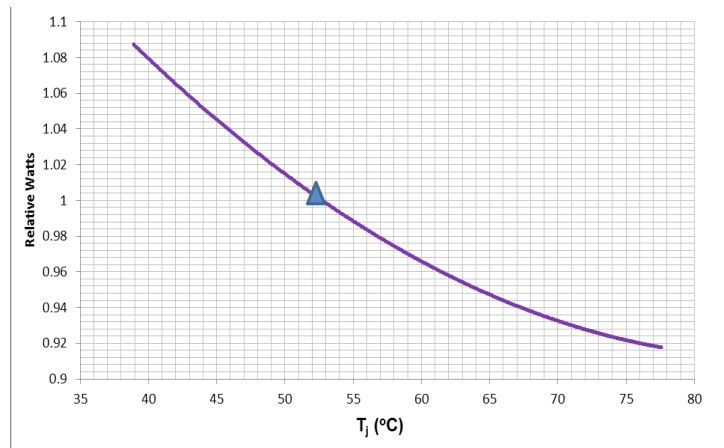
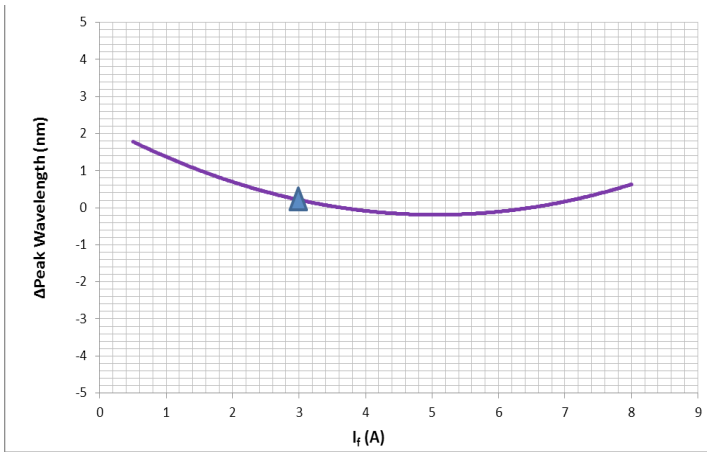
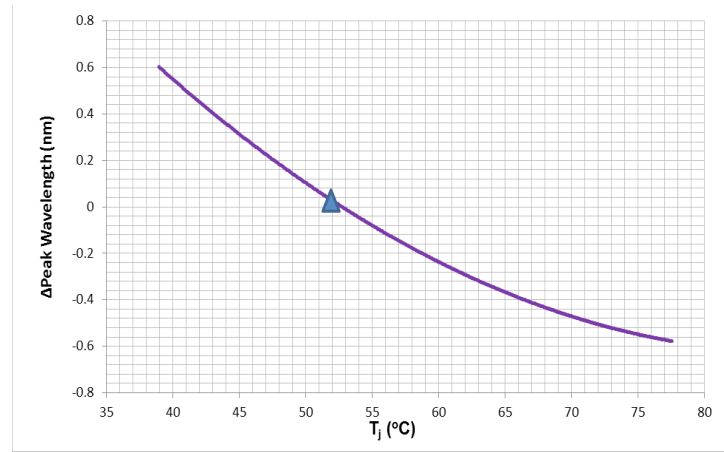
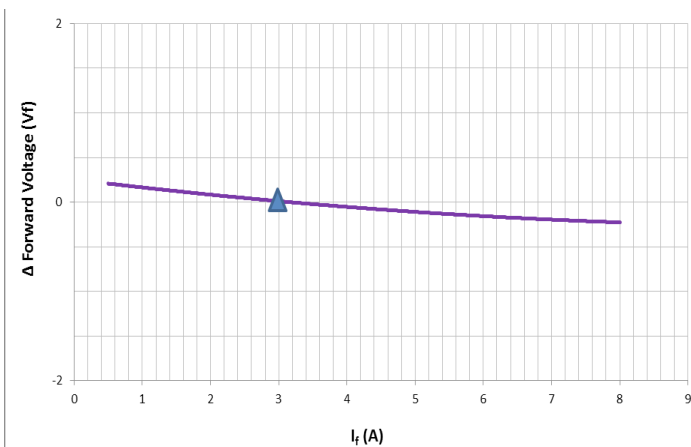
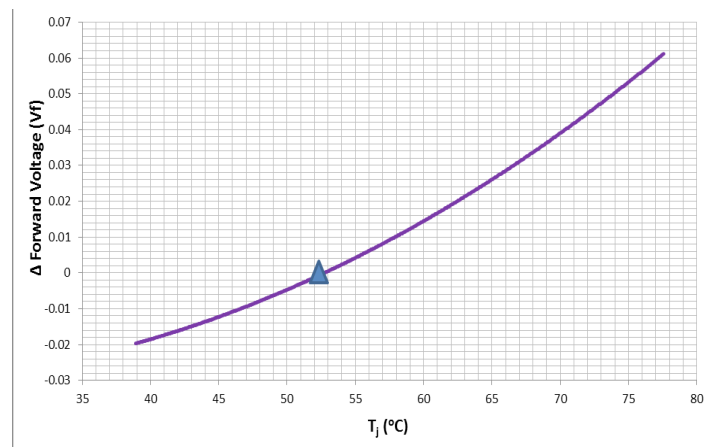
Note 8: Typical total flux from emitting area at listed peak wavelength. Reported performance is included to show trends for a selected power level. For specific minimum and maximum values, use bin tables. For product roadmap and future performance of devices, contact Luminus.

Note 9: Special design considerations must be observed for operation under 1 A. Please contact Luminus for further information.

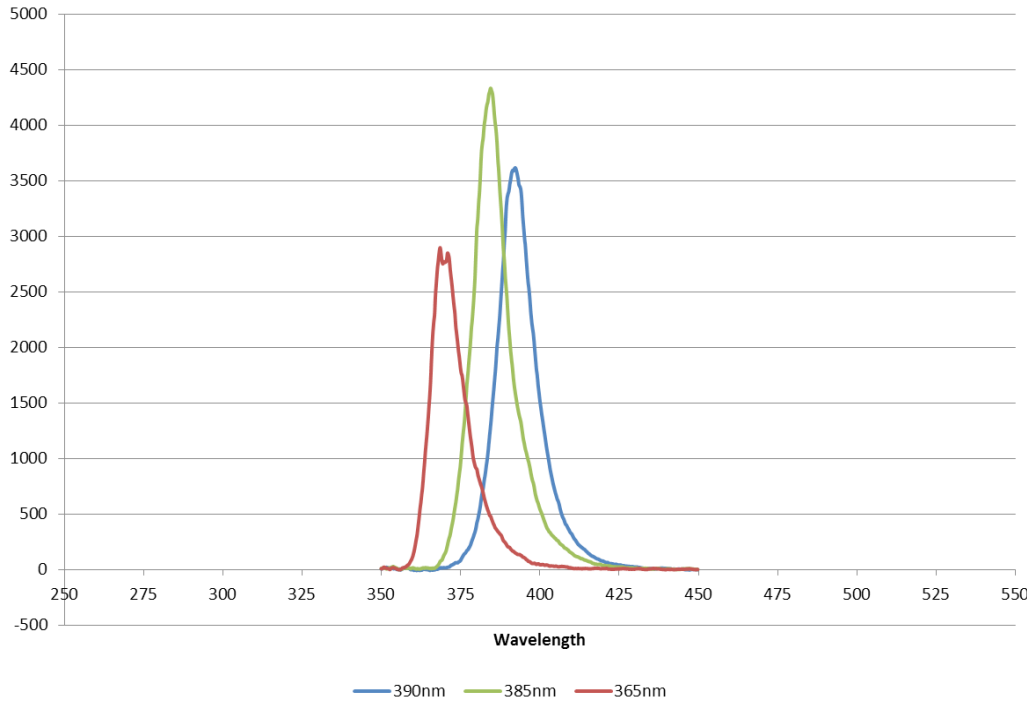
Note 10: CBM-40-UV LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at recommended forward drive currents. Sustained operation at or beyond absolute maximum currents will result in a reduction of device life time compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be longer than 0.5  $\mu\text{seconds}$ .

Note 11: Lifetime dependent on LED junction temperature. Input power and thermal system must be properly managed to ensure lifetime.

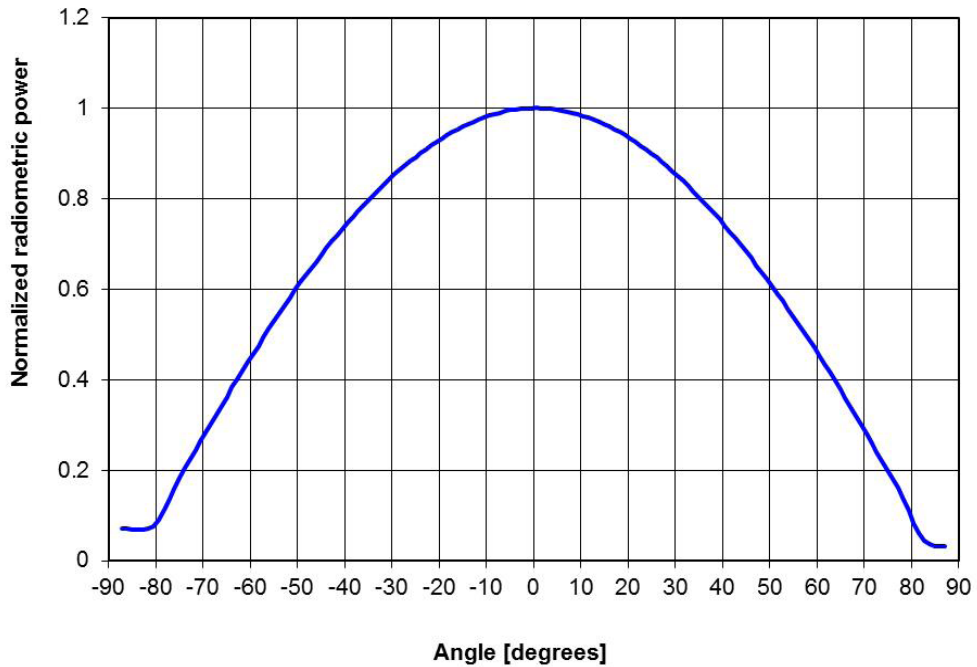
## Optical & Electrical Characteristics

**Relative Power vs Forward Current,  $T_{HS} = 40^{\circ}\text{C}$** 

**Relative Power vs Junc. Temperature**

**Peak Wavelength vs Forward Current**

**Peak Wavelength vs Junction Temperature**

**Forward Voltage vs Forward Current**

**Forward Voltage vs Junction Temperature**


### Typical Spectrum <sup>12</sup>



### Emission Angle <sup>13</sup>

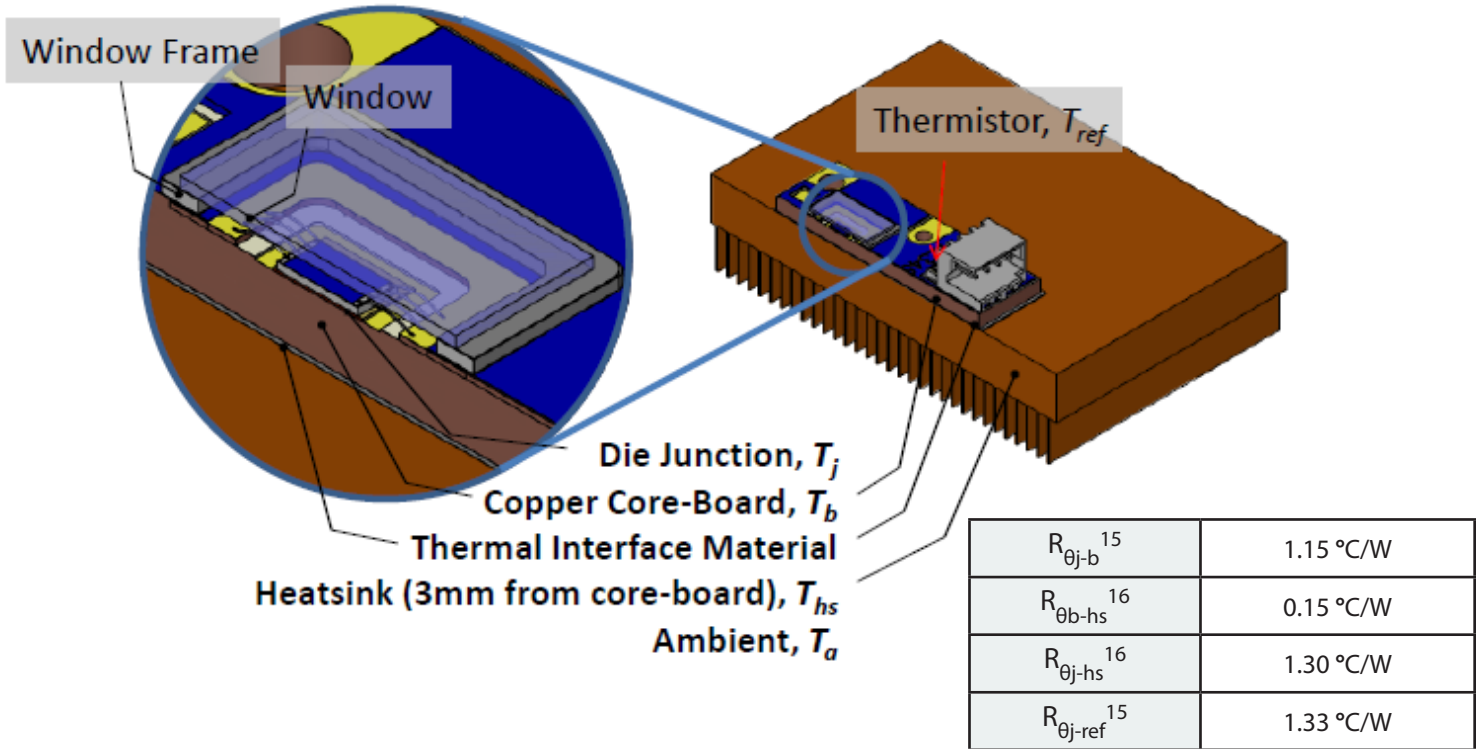


Note 12: Typical spectrum at current of 9 A in continuous operation.

Note 13: Detailed information on emission including ray trace files can be found at: <http://www.luminus.com/resource/design.html>



### Thermal Resistance CBM-40-UV



Note 14: Real thermal resistance data -“Electrical” thermal resistance values available upon request

Note 15: Thermal resistance values are based on measured wavelength shift data.

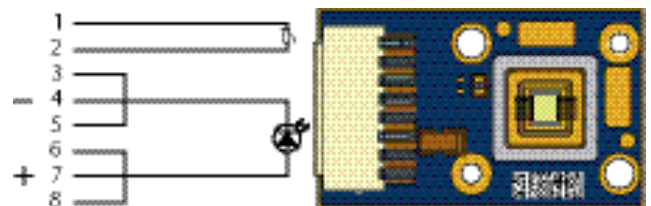
Note 16: Thermal Resistance is based on eGraf 1205 Thermal interface.

### Thermistor Information

The thermistor used in CBT-39 devices are mounted on coreboards is from Murata Manufacturing Co. The global part number is NCP18XH103J03RB. Please see <http://www.murata.com/> for details on calculating thermistor temperature.

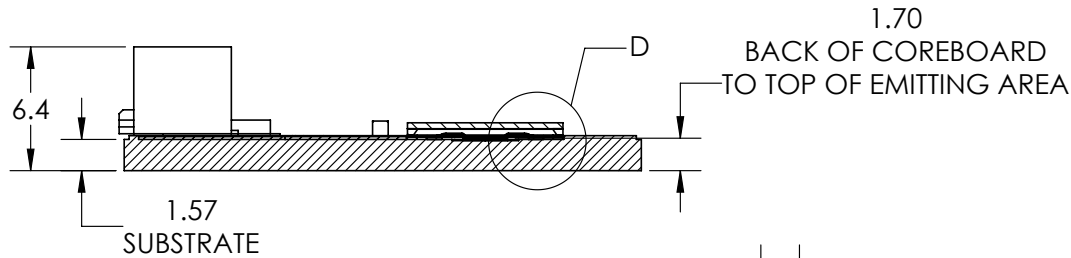
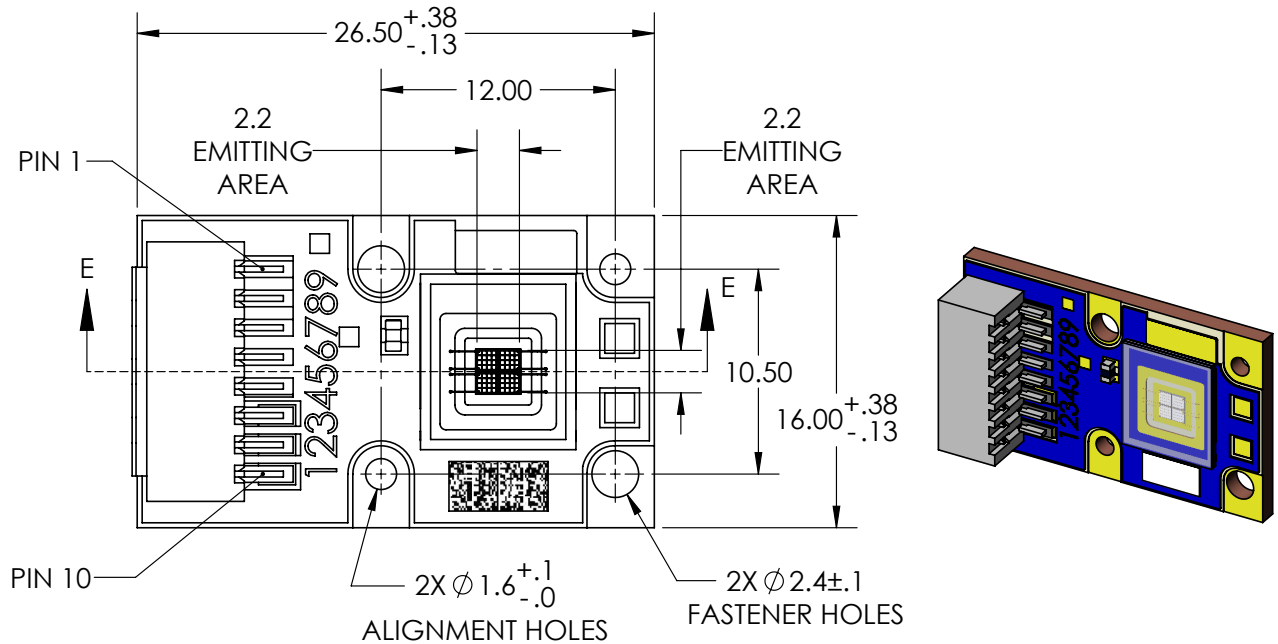
For more information on use of the thermistor, please contact Luminus directly.

### Electrical Pinout

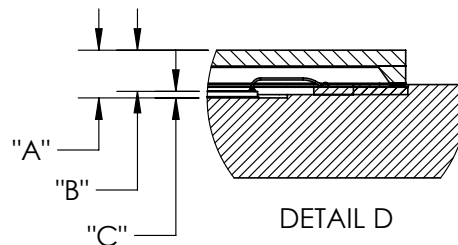


**Mechanical Dimensions – CBM-40-UV-C32 Mosaic Array LED Emitter**

DIMENSIONS IN MILLIMETERS



PIN NO(S).	ASSIGNMENT
1	THERMISTOR (+)
2	THERMISTOR (-)
3,4,5	CATHODE (-)
6,7,8	ANODE (-)

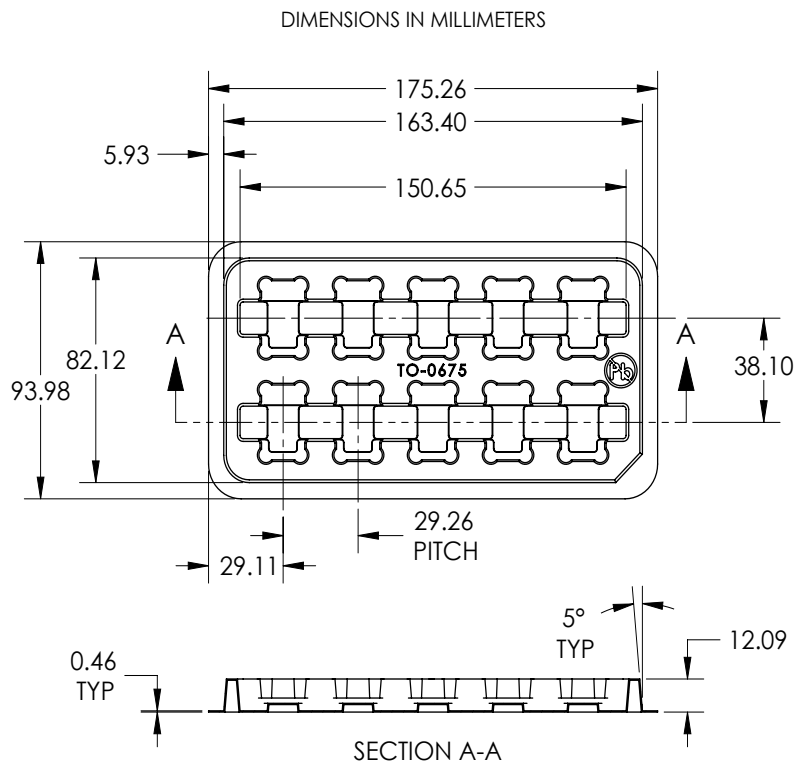


DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO TOP OF WINDOW	.91	±.13
"B"	TOP OF EMITTING AREA TO TOP OF WINDOW	.79	±.11
"C"	TOP OF METAL SUBSTRATE TO TOP OF EMITTING AREA	.13	±.02

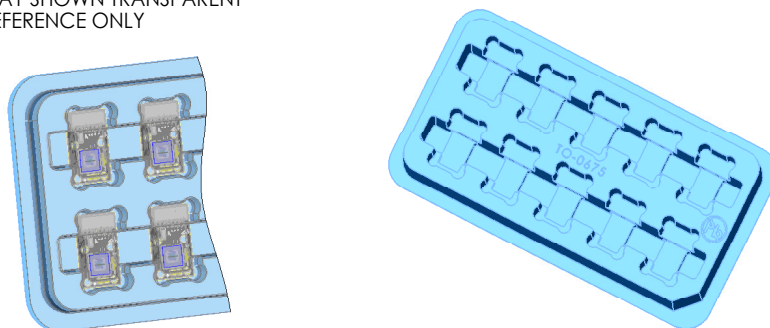
DWG-002661

- Connector- MOLEX Part Number: 874380843 or Global Part Number: WTB16-0815F.

### Shipping Tray Outline - CBM-40



TOP TRAY SHOWN TRANSPARENT  
FOR REFERENCE ONLY



## Packing and Shipping Specification (CBM-40)


### Packing Specification


Packing Configuration	Qty /Pack	Box Dimensions (diameter x W, mm)	Gross Weight (kg)
Stack of 5 trays with 10 devices per tray Each pack is enclosed in ESD bag	50	95 x 176 x 50	0.45


### Product Label Specification


#### Label Fields (subject to change):


- 6-8 digit Box number (for Luminus internal use)
- Luminus ordering part number
- Quantity of devices in pack
- Part number revision (for Luminus internal use)
- Customer's part number (optional)
- Flux Bin
- 2D Bar code





BP-012345  
  
 Box number


PT-39-G-L21-MPH  
  
 Luminus part number

12345678  
  
 Customer part number

2J  
  
 Bin

Qty: 50  


Rev 01  




for traceability peel off label and attach

**RoHS Compliant**

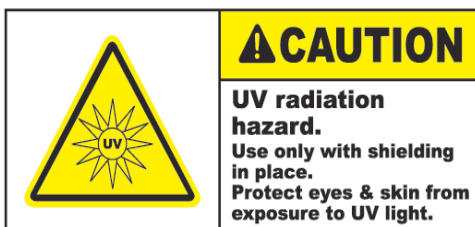
*Sample label –for illustration only*

### Shipping Box

Shipping Box	Quantity	Material	Dimensions (L x W x H, mm)
Carton Box	1 -20 packs	S4651	560 x 560 x 200

## History of Changes

Rev	Date	Description of Change
A	08/07/2015	Preliminary Specifications for 365nm and 385nm CBM-40 Parts
01	10/05/2015	Initial Release
02	03/28/2016	Updated binning information



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